IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of)
Kyo-yeol LEE) Group Art Unit: Unassigned
Application No.: New Application) Examiner: Unassigned
Filed: Herewith)
For: METHOD FOR FABRICATING GROUP III-V COMPOUND SEMICONDUCTOR SUBSTRATE)))

PRELIMINARY AMENDMENT

Assistant Commissioner for Patents Washington, D.C. 20231

Sir:

Prior to examination on the merits, kindly amend the above-captioned application as follows:

IN THE SPECIFICATION:

Kindly add the following paragraph on page 1, after the title of the invention and before the "Background of the Invention," --Priority is claimed to Patent Application

Number 2001-11153 filed in the Republic of Korea on March 5, 2001 herein incorporated by reference.--

IN THE CLAIMS:

Kindly replace claims 7, 12 and 26 as follows:

- 7. (Amended) The method of claim 1, wherein the first buffer layer is formed of multiple semiconductor material layers having different doping concentrations.
- 12. (Amended) The method of claim 1, wherein the first buffer layer is formed of a semiconductor material layer of a gradient doping concentration that increases upwards.
- 26. (Amended) The method of claim 1, wherein the semiconductor layer is a Group III-V compound semiconductor layer having conductivity.

Kindly add new claims 28-40 as follows:

- --28. (New) The method of claim 4, wherein the first buffer layer is formed of multiple semiconductor material layers having different doping concentrations.
- 29. (New) The method of claim 5, wherein the first buffer layer is formed of multiple semiconductor material layers having different doping concentrations.
- 30. (New) The method of claim 6, wherein the first buffer layer is formed of multiple semiconductor material layers having different doping concentrations.

- 31. (New) The method of claim 4, wherein the first buffer layer is formed of a semiconductor material layer of a gradient doping concentration that increases upwards.
- 32. (New) The method of claim 5, wherein the first buffer layer is formed of a semiconductor material layer of a gradient doping concentration that increases upwards.
- 33. (New) The method of claim 6, wherein the first buffer layer is formed of a semiconductor material layer of a gradient doping concentration that increases upwards.
- 34. (New) The method of claim 2, wherein the semiconductor layer is a Group III-V compound semiconductor layer having conductivity.
- 35. (New) The method of claim 15, wherein the semiconductor layer is a Group III-V compound semiconductor layer having conductivity.
- 36. (New) The method of claim 16, wherein the semiconductor layer is a Group III-V compound semiconductor layer having conductivity.
- 37. (New) The method of claim 18, wherein the semiconductor layer is a Group III-V compound semiconductor layer having conductivity.

- 38. (New) The method of claim 20, wherein the semiconductor layer is a Group III-V compound semiconductor layer having conductivity.
- 39. (New) The method of claim 23, wherein the semiconductor layer is a Group III-V compound semiconductor layer having conductivity.
- 40. (New) The method of claim 24, wherein the semiconductor layer is a Group III-V compound semiconductor layer having conductivity.--

Claims 7, 12 and 26 have been amended and claims 28-40 have been added to remove multiple dependency from the claims. The priority document has been incorporated by reference. Favorable action on the merits is respectfully requested.

Respectfully submitted,

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Date: March $\frac{4}{2}$, 2002

Attachment to Amendment

Marked-up Claims

- 7. (Amended) The method of claim 1, [4, 5, or 6,] wherein the first buffer layer is formed of multiple semiconductor material layers having different doping concentrations.
- 12. (Amended) The method of claim 1, [4, 5, or 6,] wherein the first buffer layer is formed of a semiconductor material layer of a gradient doping concentration that increases upwards.
- 26. (Amended) The method of claim 1, [2, 15, 16, 18, 20, 23, or 24,] wherein the semiconductor layer is a Group III-V compound semiconductor layer having conductivity.